

# Trench gate field-stop IGBT, M series 650 V, 6 A low loss

Datasheet - production data

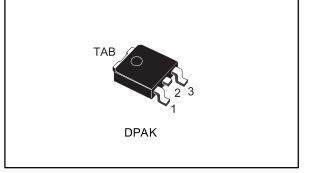
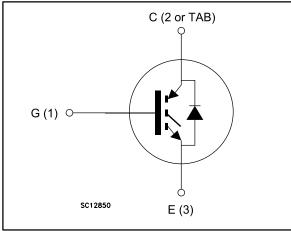


Figure 1: Internal schematic diagram



### Features

- 6 µs of short-circuit withstand time
- V<sub>CE(sat)</sub> = 1.55 V (typ.) @ I<sub>C</sub> = 6 A
- Tight parameter distribution
- Safer paralleling
- Low thermal resistance
- Soft and very fast recovery antiparallel diode

### **Applications**

- Motor control
- UPS
- PFC

### Description

This device is an IGBT developed using an advanced proprietary trench gate field-stop structure. The device is part of the M series IGBTs, which represent an optimal balance between inverter system performance and efficiency where low-loss and short-circuit functionality are essential. Furthermore, the positive  $V_{CE(sat)}$  temperature coefficient and tight parameter distribution result in safer paralleling operation.

#### Table 1: Device summary

Order code	Marking	Package	Packing
STGD6M65DF2	G6M65DF2	DPAK	Tape and reel

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This is information on a product in full production.

### Contents

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# 1 Electrical ratings

 Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
VCES	Collector-emitter voltage (V <sub>GE</sub> = 0 V)	650	V
la la	Continuous collector current at $T_C = 25$ °C	12	А
lc	Continuous collector current at T <sub>c</sub> = 100 °C	6	А
ICP <sup>(1)</sup>	Pulsed collector current	24	А
$V_{GE}$	Gate-emitter voltage	±20	V
I_	Continuous forward current at T <sub>C</sub> = 25 °C	12	А
IF	Continuous forward current at T <sub>C</sub> = 100 °C	6	А
I <sub>FP</sub> <sup>(1)</sup>	Pulsed forward current	24	А
Ртот	Total dissipation at $T_C = 25$ °C	88	W
Tstg	Storage temperature range - 55 to 150		°C
TJ	Operating junction temperature range	- 55 to 175	°C

#### Notes:

 $^{(1)}\mbox{Pulse}$  width limited by maximum junction temperature.

#### Table 3: Thermal data

Symbol	Parameter	Value	Unit
RthJC	Thermal resistance junction-case IGBT	1.7	°C/W
RthJC	Thermal resistance junction-case diode	5	°C/W
RthJA	Thermal resistance junction-ambient	100	°C/W



ICES

 $I_{\text{GES}}$ 

25

±250

μΑ

μΑ

# 2 Electrical characteristics

 $T_C = 25$  °C unless otherwise specified

Collector cut-off current

Gate-emitter leakage current

Table 4: Static characteristics							
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit	
$V_{(BR)CES}$	Collector-emitter breakdown voltage	$V_{GE}=0~V,~I_C=250~\mu A$	650			V	
		$V_{GE} = 15 \text{ V}, I_C = 6 \text{ A}$		1.55	2.0		
V <sub>CE(sat)</sub> Collector-emitter saturation voltage	V <sub>GE</sub> = 15 V, I <sub>C</sub> = 6 A, T <sub>J</sub> = 125 °C		1.9		V		
	Voltage	$V_{GE} = 15 \text{ V}, I_C = 6 \text{ A},$ T <sub>J</sub> = 175 °C		2.1			
		IF = 6 A		2.2			
VF	Forward on-voltage	I <sub>F</sub> = 6 A, T <sub>J</sub> = 125 °C		2.0		V	
		I <sub>F</sub> = 6 A, T <sub>J</sub> = 175 °C		1.9			
$V_{\text{GE(th)}}$	Gate threshold voltage	$V_{CE} = V_{GE}, I_C = 250 \ \mu A$	5	6	7	V	

#### Table 5: Dynamic characteristics

 $V_{GE} = 0 V, V_{CE} = 650 V$ 

 $V_{CE}=0~V,~V_{GE}=\pm~20~V$ 

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Cies	Input capacitance		-	530	-	
Coes	Output capacitance	V <sub>CE</sub> = 25 V, f = 1 MHz, V <sub>GE</sub> = 0 V	-	31	-	pF
Cres	Reverse transfer capacitance	-	-	11	-	
Qg	Total gate charge		-	21.2	-	
Q <sub>ge</sub>	Gate-emitter charge	$V_{CC} = 520 \text{ V}, I_C = 6 \text{ A}, V_{GE} = 15 \text{ V}$ (see Figure 30: " Gate charge test	-	5.2	-	nC
Q <sub>gc</sub>	Gate-collector charge	circuit")	-	8.8	-	

#### Electrical characteristics

Table 6: IGBT switching characteristics (inductive load)						
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t <sub>d(on)</sub>	Turn-on delay time			15	-	ns
tr	Current rise time			5.8	-	ns
(di/dt) <sub>on</sub>	Turn-on current slope			828	-	A/µs
$t_{d(off)}$	Turn-off-delay time			90	-	ns
tf	Current fall time	$V_{CE} = 400 \text{ V}, \text{ Ic} = 6 \text{ A}, \text{ V}_{GE} = 15 \text{ V},$ $R_G = 22 \Omega \text{ (see Figure 29: "Test circuit}$ for inductive load switching")		130	-	ns
E <sub>on</sub> <sup>(1)</sup>	Turn-on switching energy			0.036	-	mJ
E <sub>off</sub> <sup>(2)</sup>	Turn-off switching energy			0.200	-	mJ
Ets	Total switching energy			0.236	-	mJ
t <sub>d(on)</sub>	Turn-on delay time			17	-	ns
tr	Current rise time			7	-	ns
(di/dt) <sub>on</sub>	Turn-on current slope			685	-	A/µs
$t_{d(off)}$	Turn-off-delay time			86	-	ns
t <sub>f</sub>	Current fall time	$V_{CE} = 400 \text{ V}, I_C = 6 \text{ A}, V_{GE} = 15 \text{ V},$ $R_G = 22 \Omega T_J = 175 \text{ °C} (\text{see Figure 29: "}$ Test circuit for inductive load switching")		205	-	ns
Eon <sup>(1)</sup>	Turn-on switching energy			0.064	-	mJ
E <sub>off</sub> <sup>(2)</sup>	Turn-off switching energy			0.290	-	mJ
E <sub>ts</sub>	Total switching energy	-		0.354	-	mJ
t <sub>sc</sub>	Short-circuit	$V_{CC} \le 400 \text{ V}, \text{ V}_{GE} = 15 \text{ V}, \text{ T}_{Jstart} = 150 ^{\circ}\text{C}$	6		-	μs
•SC	withstand time	V <sub>CC</sub> ≤ 400 V, V <sub>GE</sub> = 13 V, T <sub>Jstart</sub> = 150 °C	10		-	μs

#### Notes:

 $^{(1)}\ensuremath{\mathsf{Turn}}\xspace$  on switching energy includes reverse recovery of the diode.

 $^{(2)}\mbox{Turn-off}$  switching energy also includes the tail of the collector current.



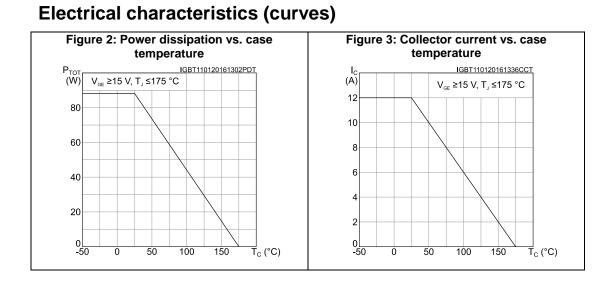
#### Electrical characteristics

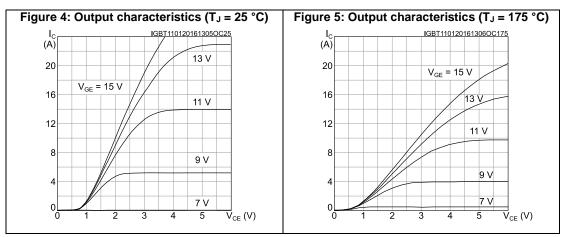
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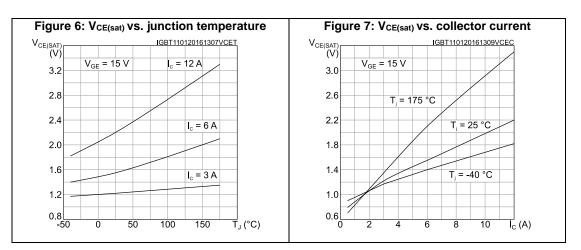
Table 7: Diode switching characteristics (inductive load)						
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
trr	Reverse recovery time		-	140	-	ns
Qrr	Reverse recovery charge	IF = 6 A, $V_R$ = 400 V, $V_{GE}$ = 15 V (see Figure 29: "Test circuit for inductive load switching") di/dt = 1000 A/µs		210	-	nC
Irrm	Reverse recovery current			6.6	-	А
dIrr/dt	Peak rate of fall of reverse recovery current during t <sub>b</sub>			430	-	A/µs
Err	Reverse recovery energy			16	-	μJ
t <sub>rr</sub>	Reverse recovery time			200	-	ns
Qrr	Reverse recovery charge		-	473	-	nC
Irrm	Reverse recovery current	$I_{F} = 6 \text{ A}, V_{R} = 400 \text{ V}, V_{GE} = 15 \text{ V}$ $T_{J} = 175 \text{ °C} (\text{see Figure 29: "Test}$ circuit for inductive load switching") di/dt = 1000 A/µs		9.6	-	А
dlrr/dt	Peak rate of fall of reverse recovery current during t <sub>b</sub>			428	-	A/µs
Err	Reverse recovery energy		-	32	-	μJ



2.1







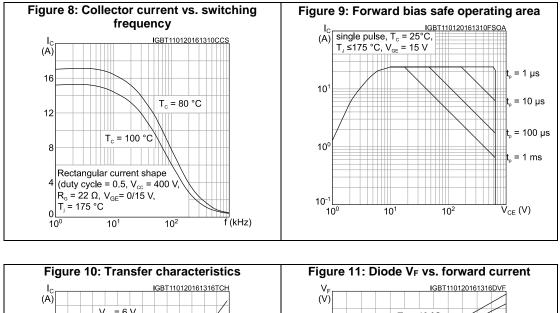
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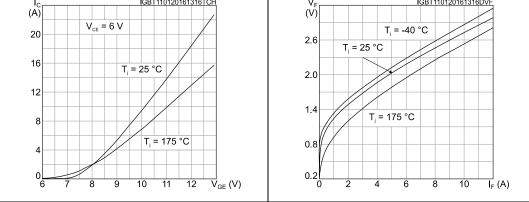
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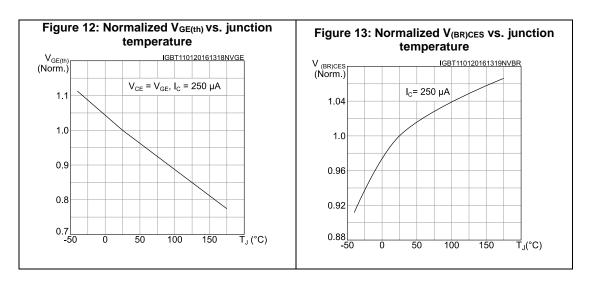
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#### **Electrical characteristics**

#### STGD6M65DF2



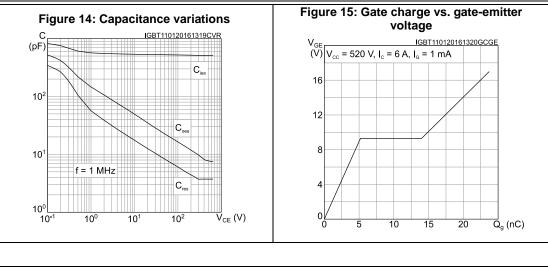


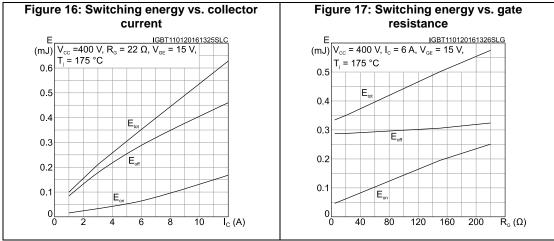


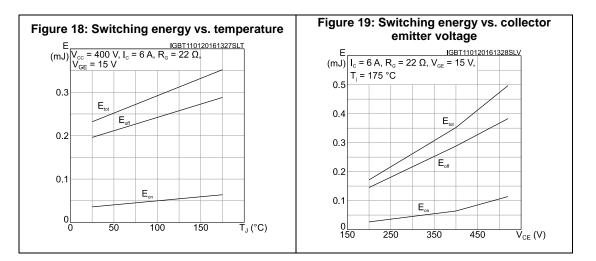


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#### **Electrical characteristics**

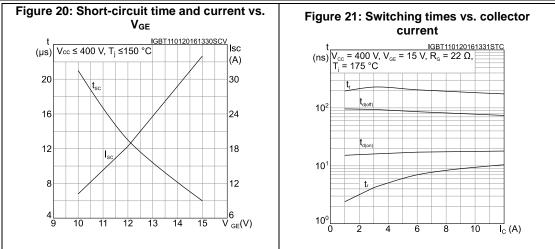


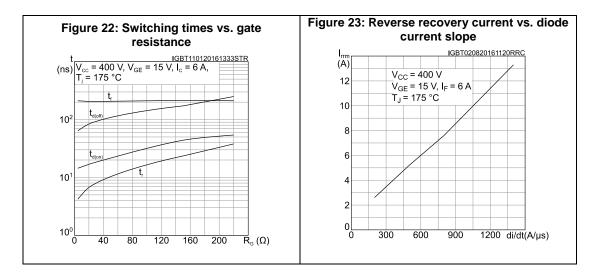


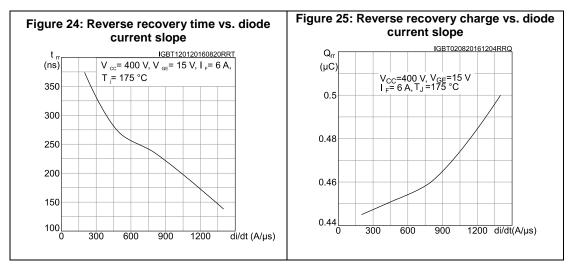


#### **Electrical characteristics**

#### STGD6M65DF2

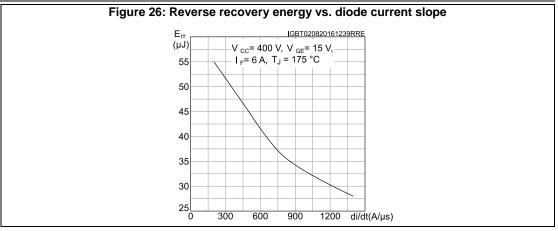


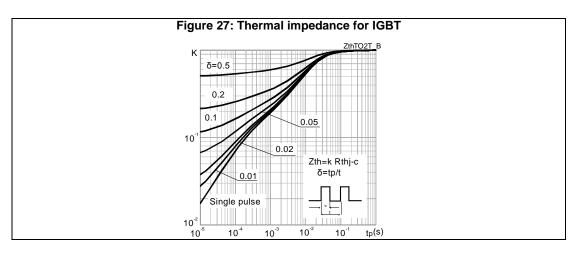


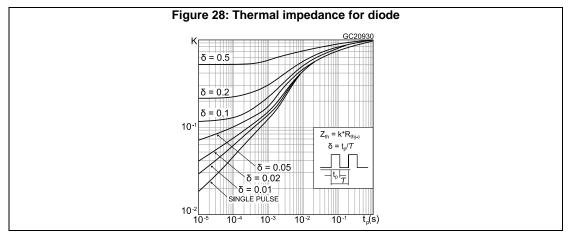




#### **Electrical characteristics**

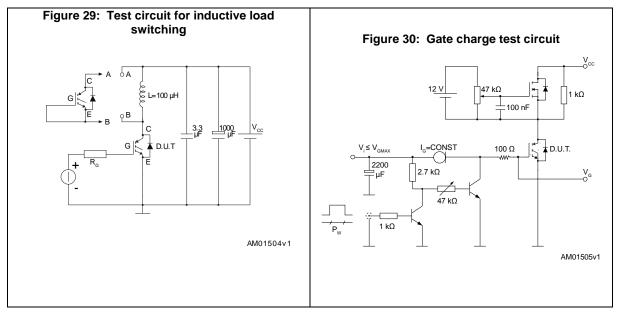


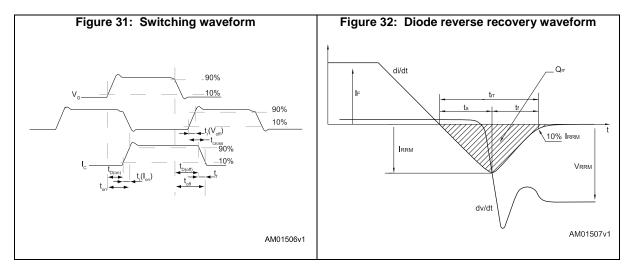




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### 3 Test circuits







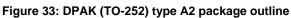
### 4 Package information

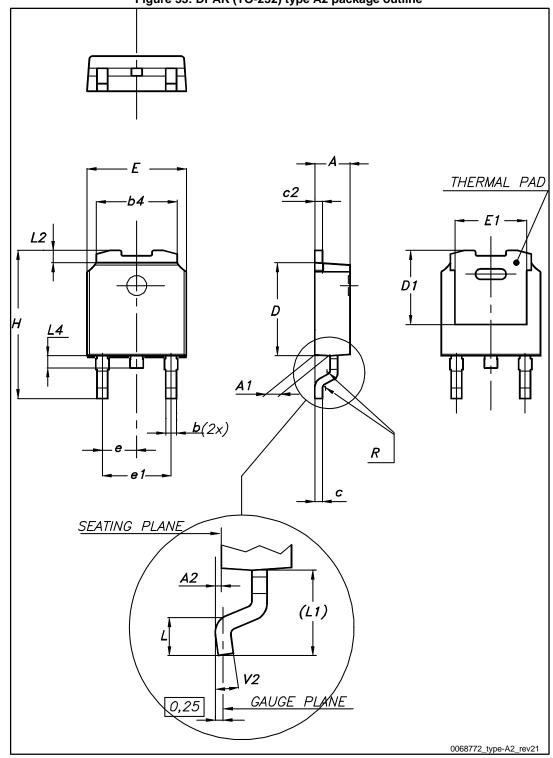
In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK<sup>®</sup> is an ST trademark.



Package information









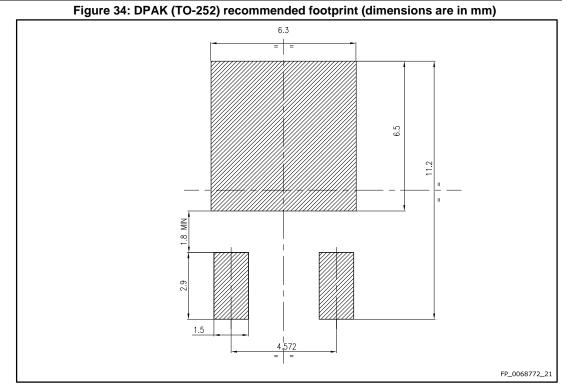
#### Package information

5DF2	Package informati					
	Table 8: DPAK (TO-252	) type A2 mechanical da	ta			
Dim.		mm				
Dini.	Min.	Тур.	Max.			
A	2.20		2.40			
A1	0.90		1.10			
A2	0.03		0.23			
b	0.64		0.90			
b4	5.20		5.40			
С	0.45		0.60			
c2	0.48		0.60			
D	6.00		6.20			
D1	4.95	5.10	5.25			
E	6.40		6.60			
E1	5.10	5.20	5.30			
е	2.16	2.28	2.40			
e1	4.40		4.60			
Н	9.35		10.10			
L	1.00		1.50			
L1	2.60	2.80	3.00			
L2	0.65	0.80	0.95			
L4	0.60		1.00			
R		0.20				
V2	0°		8°			



#### Package information

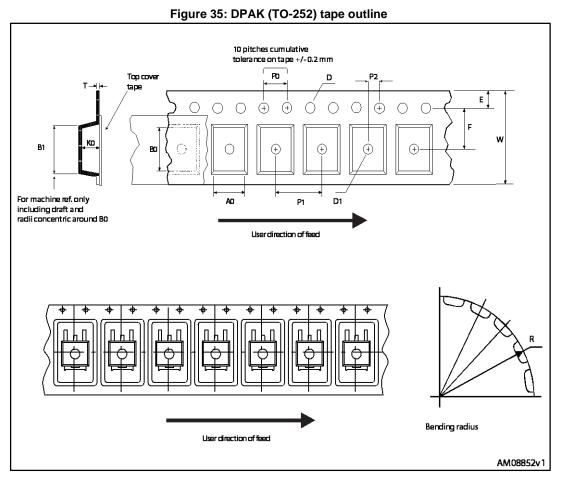
#### STGD6M65DF2







## 4.2 DPAK (TO-252) packing information





#### Figure 36: DPAK (TO-252) reel outline

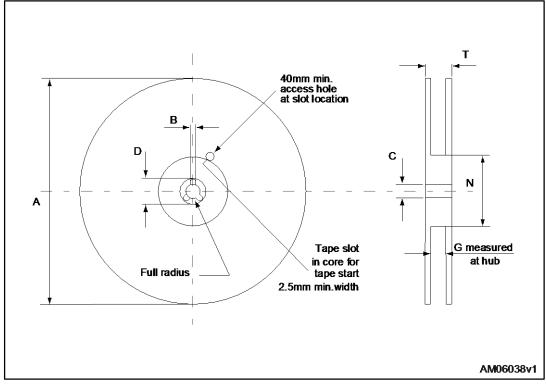


Table 9: DPAK (TO-252) tape and reel mechanical data					
	Таре			Reel	
Dim	r	nm	Dim	m	ım
Dim.	Min.	Max.	Dim.	Min.	Max.
A0	6.8	7	А		330
B0	10.4	10.6	В	1.5	
B1		12.1	С	12.8	13.2
D	1.5	1.6	D	20.2	
D1	1.5		G	16.4	18.4
Е	1.65	1.85	Ν	50	
F	7.4	7.6	Т		22.4
K0	2.55	2.75			
P0	3.9	4.1	Bas	e qty.	2500
P1	7.9	8.1	Bul	k qty.	2500
P2	1.9	2.1			
R	40				
Т	0.25	0.35			
W	15.7	16.3			

#### Table 9: DPAK (TO-252) tape and reel mechanical data



## 5 Revision history

Table 10:	Document	revision	history
10010 101	Doodinonit		

Date	Revision	Changes	
30-Nov-2015	1	First release.	
13-Jan-2016	2	Modified: Table 4: "Static characteristics", Table 5: "Dynamic characteristics", Table 6: "IGBT switching characteristics (inductive load)" and Table 7: "Diode switching characteristics (inductive load)" Added: Section 2.1: "Electrical characteristics (curves)" Minor text changes	
04-Aug-2016 3		Updated: Table 2: "Absolute maximum ratings", Table 4: "Static characteristics", Table 6: "IGBT switching characteristics (inductive load)", Table 7: "Diode switching characteristics (inductive load)". Updated Figure 9: "Forward bias safe operating area", Figure 12: "Normalized VGE(th) vs. junction temperature", Figure 20: "Short-circuit time and current vs. VGE", Figure 23: "Reverse recovery current vs. diode current slope". Changed: Figure 25: "Reverse recovery charge vs. diode current slope",	
		and <i>Figure 26: "Reverse recovery energy vs. diode current slope"</i> . Document status promoted from preliminary to production data.	



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